

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Seiji YAMADA

JC12 Rec'd PCT/PTC 26 APR 2005

#3

Application No.: New U.S. National Stage of PCT/JP03/13414

Filed: April 26, 2005

Docket No.: 123655

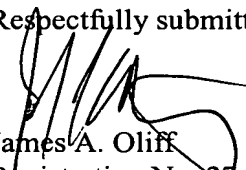
For: FORMING DIE FOR CONTACT LENS AND CONTACT LENS MANUFACTURING
METHOD USING THE FORMING DIEINFORMATION DISCLOSURE STATEMENTCommissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Pursuant to 37 CFR §1.56, the attention of the Patent and Trademark Office is hereby directed to the references listed on the attached PTO-1449. Unless otherwise indicated herein, one copy of each reference is attached. It is respectfully requested that the information be expressly considered during the prosecution of this application, and that the references be made of record therein and appear among the "References Cited" on any patent to issue therefrom.

- ☒ 1. This Information Disclosure Statement is being filed (a) within three months of the U.S. filing date of this non-CPA application, OR (b) before the mailing date of a first Office Action on the merits in the present application. No certification or fee is required.
- ☒ 2. Relevance of references 7-10, 12-13 is discussed in the present specification.
- ☒ 3. References 5-6, 15-16 were cited in the International Search Report. An English language version of the International Search Report is attached for the Examiner's information.
- ☒ 4. In accordance with 37 CFR §1.98(a)(2)(ii), copies of any U.S. patents and patent application publications are not attached.
- ☒ 5. English language Abstracts of references 7-10, 12-13, and 16 are attached hereto.
- ☒ 6. Computer-generated English language translations of the following Japanese references have been obtained from the website of the Japanese Patent Office ([<http://www.jpo.go.jp>]), and are attached, but have not been reviewed for accuracy. See References 10, 12, and 16.
- ☒ 7. References 1 and 2 correspond to Reference 7. Reference 3 corresponds to Reference 8. Reference 4 corresponds to Reference 9. Reference 11 corresponds to Reference 10. Reference 14 corresponds to Reference 13.

Respectfully submitted,


James A. Oliff
Registration No. 27,075Joel S. Armstrong
Registration No. 36,430

JAO:JSA/nxy

Date: April 26, 2005

OLIFF & BERRIDGE, PLC
P.O. Box 19928
Alexandria, Virginia 22320
Telephone: (703) 836-6400DEPOSIT ACCOUNT USE
AUTHORIZATIONPlease grant any extension
necessary for entry;
Charge any fee due to our
Deposit Account No. 15-0461

10/532809

Form PTO-1449 (REV. 8-83) US Dept. of Commerce PATENT & TRADEMARK OFFICE INFORMATION DISCLOSURE STATEMENT (Use several sheets if necessary)	ATTY DOCKET NO. 123655	APPLICATION NO. New U.S. National Stage of PCT/JP03/13414
	APPLICANT Seiji YAMADA	
	FILING DATE April 26, 2005	GROUP

U.S. PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS
	1.	4,113,224	09/12/1978	James A. CLARK et al.		
	2.	4,197,266	04/08/1980	James A. CLARK et al.		
	3.	4,209,289	06/24/1980	Paul D. NEWCOMB et al.		
	4.	5,143,660	09/01/1992	Ronald S. HAMILTON et al.		
	5.	5,894,002	04/13/1999	Karlheinz BONEBERGER et al.		
	6.	5,271,875	12/21/1993	William J. APPLETON et al.		

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUB CLASS
	7.	JP-A-50-151966 w/ abst.	12/06/1975	JAPAN		
	8.	JP-A-55-151618 w/ abst.	11/26/1980	JAPAN		
	9.	JP-A-02-172712 w/ abst.	07/04/1990	JAPAN		
	10.	JP-A-06-208090 w/ abst. & trans.	07/26/1994	JAPAN		
	11.	EP 0 545 720 A1	06/09/1993	EUROPEAN PATENT OFFICE		
	12.	JP-A-2000-289041 w/ abst. & trans.	10/17/2000	JAPAN		
	13.	JP-A-01-500256 w/ abst.	02/02/1989	JAPAN		
	14.	WO 87/04390 A1	07/30/1987	WIPO		
	15.	WO 01/17756 A1	03/15/2001	WIPO		
	16.	JP-A-2003-019724 w/ abst. & trans.	01/21/2003	JAPAN		

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.)

EXAMINER	DATE CONSIDERED
Examiner: Initial if citation considered, whether or not citation is in conformance with M.P.E.P. 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.	

Date: April 26, 2005